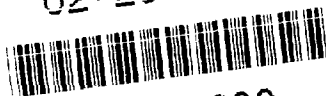




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02-20-2003



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ocket No.: NEC A374

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Patent and Trademark Office

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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Yoshikazu NISHIMURA

2-12-03

Additional names(s) of conveying party(ies)

☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment

☐ Merger

☐ Security Agreement

☐ Change of Name

☐ Other

Execution Date: 12/17/02

2. Name and address of receiving party(ies):

Name: NEC Compound Semiconductor Devices, Ltd.

Address: 1753 Shimonumabe

Nakahara-ku, Kawasaki

City: Kanagawa

State/Prov.:

Country: JAPAN

ZIP: 211-8666

Additional name(s) & address(es)

☐ Yes ☒ No

4. Application number(s) or patent numbers(s):

If this document is being filed together with a new application, the execution date of the application is:

Patent Application No.

Filing date

B. Patent No.(s)

10/324,404

December 19, 2002

02/13/2003 JBALINAN 00000104 10324404

01 FC:8021

40.00 OP

Additional numbers

☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Norman P. Soloway

Registration No. 24,315

Address: HAYES SOLOWAY P.C.

130 W. Cushing Street

City: Tucson

State/Prov.: AZ

Country: U.S.A.

ZIP: 85701

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ 40.00

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Name of Person Signing

Signature

February 7, 2003

Date

2

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PATENT
REEL: 013756 FRAME: 0871

2001-326201
(177)pat. A374

ASSIGNMENT

FOREIGN - IN THE UNITED STATES OF AMERICA


I/we, Yoshikazu NISHIMURA of Tokyo, Japan, having invented certain inventions and improvements in HIGH-FREQUENCY CIRCUIT
_____ and having executed an application for Letters Patent of the United States of America describing the same and based thereon on _____; for good and valuable consideration, the receipt of which is hereby acknowledged from **NEC Compound Semiconductor Devices, Ltd.**, a Japanese corporation having its principal place of business at 1753 Shimonumabe, Nakahara-ku, Kawasaki, Kanagawa 211-8666, Japan, (hereinafter called the assignee), do hereby sell, assign and transfer unto the Assignee, its successors, and assign my/our entire right, title, and interest, in and to said invention in the United States of America, including all rights, title and interest in the above-mentioned application and any divisional, continuing or reissue application or applications and any patent which may be issued on the said invention in the United States of America;

And for the same consideration I/we will upon request execute any instrument which the Assignee may desire to carry this Assignment into effect and perfect the title transferred hereby or prosecute the above-mentioned application;

And I/we do hereby authorize and request the Commissioner of Patent and Trademarks of the United States of America to issue Letters Patent on the said application to the Assignee;

And I/we do hereby jointly and severally covenant for ourselves and for our legal representatives that I/we have granted no right or license to make, use, or sell said inventions to anyone except the assignee, that prior to the execution of this deed our right, title, and interest in and to said inventions or any of them or any part thereof has not been otherwise encumbered by us, and that I/we have not executed any instrument in conflict herewith.

IN WITNESS WHEREOF, I/we hereunto set our hands and seals on the day and year hereinafter noted.

First Inventor's signature Yoshikazu Nishimura  Date December 17, 2002
Full name of first inventor: Yoshikazu NISHIMURA

Witness: Hitoshi Ukeni
Date: December 17, 2002

Witness: [Signature]
Date: December 17, 2002